



Product Change Notification

108118 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 108118 - 01
Change Title: SSR212MC2BR/ SSR212MC2RBR, PCN 108118-01, Product Material, Hard Tooled Chassis, New Boot Drive Enclosure, RAID Card FW Update.

Reason for Revision: Schedule change.

Date of Publication: February 20, 2007

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 29, 2008
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Description of Change to the Customer:

1. Introduce hard tooled chassis parts.
2. Improved boot drive enclosure without mass damper.
3. Mini-USB adapter added to accessory kit.
4. RAID card FW update to 1.12.00-0310.
- 5. Enclosure Management card FW update to 1.0.3-55.**
6. Storview™ SW update to 3.07.0006.
7. Updated Resource CD to D91204-004.
8. Updated Attention Document to D91601-004.
9. Updated Quick Start Guide to D91284-002.

Customer Impact of Change and Recommended Action:

FYI - only.

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Post Change MM#	Pre Change TA#	Post Change TA#
SSR212MC2RBR	893519	893519	D88965-004	D88965-005
SSR212MC2BR	893628	893628	D88964-004	D88964-005
SSR212MC2RBRNA	894040	894040	D88965-004	D88965-005
SSR212MC2BRNA	894041	894041	D88964-004	D88964-005

Pre Conversion Product Code	Pre Conversion MM#	Post Conversion MM#
FMCCHASSIS	890449	896728
FMCBOOTENCL	890490	896756

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

December 20, 2007

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Originally Published PCN

February 20, 2008

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Updated EM FW revision to 1.0.3-55, updated post conversion date to February 29, 2008.